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				110000				Notification Date:				January 25, 2017		
Title: Datasheet for SN74AHC14Q-Q1														
Customer Contact: PCN Manager				Dept: Quality Services										
Cha	nge Type:													
	Assembly Site	9				De	sig	n					Wafe	r Bump Site
	Assembly Process			☐ Data Sheet							Wafer Bump Material			
	Assembly Materials					Part number change							Wafe	r Bump Process
	Mechanical Specification					Test Site						Wafe	r Fab Site	
	Packing/Shipping/Labeling				Test Process							Wafe	r Fab Materials	
											Wafe	r Fab Process		
Notification Details														
Description of Change:														
Texas Instruments Incorporated is announcing an information only notification.														
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The product datasheet(s) is updated to change the MSL level of SN74AHC14QPWRQ1 from MSL-														
3 to MSL-1 under PACKAGE OPTION ADDENDUM page.														
There is no bill of material change to the actual device and this is a datasheet update/correction														
only.														
These changes may be reviewed at the datasheet links provided.														
	-	•								s provide	u.			
http://www.ti.com/lit/ds/symlink/sn74ahc14q-q1.pdf														
From														
PACKAGING INFORMATION														
SN7	4AHC14QPWRQ1	AC	TIVE	TSSOP		PW		14	2000	Green (Rol		CU	NIPDAU	Level-3-260C-168 HR
										no Sb/B				
To:														
PACKAGING INFORMATION														
SN74	AHC14QPWRQ1	ACTI\	Æ	TSSOP	Р	W	14	2000) (Green (RoHS & no Sb/Br)		CU N	IPDAU	Level-1-260C-UNLIM
										a no obibi)				
Rea	son for Chan	ae:												
To more accurately reflect device characteristics.														
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):														
No anticipated impact. This is a specification change announcement only. There are no changes														
to the actual device														
Changes to product identification resulting from this notification:														
None	e.													
Proc	luct Affected	l:												
SN74AHC14QPWRQ1														
For questions regarding this notice, e-mails can be sent to the regional contacts shown below														
ror (_l uestions rega	ıruıng	เกเร	notice,	e-r	mall	s Ca	an be	se	nt to the	reg	เบทอ	ıı cont	acts snown below

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com